MOSFET – Power, Single, P-Channel, SC-70

-8.0 V, -1.4 A

NTS2101P

Features

- Leading Trench Technology for Low R_{DS(on)} Extending Battery Life
- -1.8 V Rated for Low Voltage Gate Drive
- SC-70 Surface Mount for Small Footprint (2 x 2 mm)
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- High Side Load Switch
- Charging Circuit
- Single Cell Battery Applications such as Cell Phones, Digital Cameras, PDAs, etc.

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

Parame	ter		Symbol	Value	Units			
Drain-to-Source Voltage			V _{DSS}	-8.0	V			
Gate-to-Source Voltage	te-to-Source Voltage			±8.0	V			
Continuous Drain	Steady T _A = 25° State		۱ _D	-1.4	А			
Current (Note 1)	State	$T_A = 70^{\circ}C$		-1.1				
	t ≤ 5 s	$T_A = 25^{\circ}C$		-1.5	А			
Power Dissipation (Note 1)	Steady State	$T_A = 25^{\circ}C$	PD	0.29	W			
	t≤5 s			0.33	W			
Pulsed Drain Current	tp =	= 10 μs	I _{DM}	-3.0	А			
Operating Junction and St	torage Tei	mperature	T _J , T _{STG}	–55 to 150	°C			
Source Current (Body Dio	de), Cont	inuous	۱ _S	-0.46	А			
Lead Temperature for Solo (1/8" from case for 10		rposes	ΤL	260	°C			

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Units
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	430	°C/W
Junction-to-Ambient – t \leq 5 s (Note 1)	$R_{\theta JA}$	375	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).

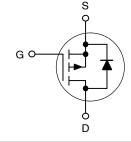


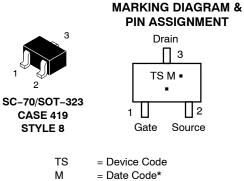
ON Semiconductor®

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V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max
	65 mΩ @ –4.5 V	
-8.0 V	78 mΩ @ –2.5 V	–1.4 A
	117 mΩ @ –1.8 V	







⁼ Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
NTS2101PT1	SOT-323	3000/Tape & Reel
NTS2101PT1G	SOT-323 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise stated)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFE CHARACTERISTICS						

OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = -250 μ A		-8.0	-20		V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				-10		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = -6.4 V	$T_J = 25^{\circ}C$			-1.0	μΑ
		V _{DS} = -6.4 V	$T_J = 70^{\circ}C$			-5.0	1
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±8.0 V				±100	nA

ON CHARACTERISTICS (Note 2)

Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = -250 μ A	-0.45	-0.7	-1.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J			2.6		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = -4.5 V, I _D = -1.0 A		65	100	mΩ
		V_{GS} = -2.5 V, I _D = -0.5 A		78	140	
		V_{GS} = -1.8 V, I _D = -0.3 A		117	210	

CHARGES AND CAPACITANCES

Input Capacitance	C _{ISS}	$V_{GS} = 0 V, f = 1.0 MHz,$	640	pF
Output Capacitance	C _{OSS}	V _{DS} = -8.0 V	120	
Reverse Transfer Capacitance	C _{RSS}		82	
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -5.0 \text{ V}, V_{DD} = -5.0 \text{ V},$ $I_{D} = -1.0 \text{ A}$	6.4	nC
Threshold Gate Charge	Q _{G(TH)}	$I_{\rm D} = -1.0 \rm A$	0.7	
Gate-to-Source Charge	Q _{GS}		1.0	
Gate-to-Drain Charge	Q _{GD}		1.5	1

SWITCHING CHARACTERISTICS (Note 3)

Turn-On Delay Time	t _{d(ON)}	$V_{GS} = -4.5$ V, $V_{DD} = -4.0$ V, $I_D = -1.0$ A, $R_G = 6.2$ Ω	6.2	ns
Rise Time	t _r	$I_{\rm D} = -1.0$ A, $\Pi_{\rm G} = 0.2$ S2	15	
Turn-Off Delay Time	t _{d(OFF)}		26	
Fall Time	t _f		18	

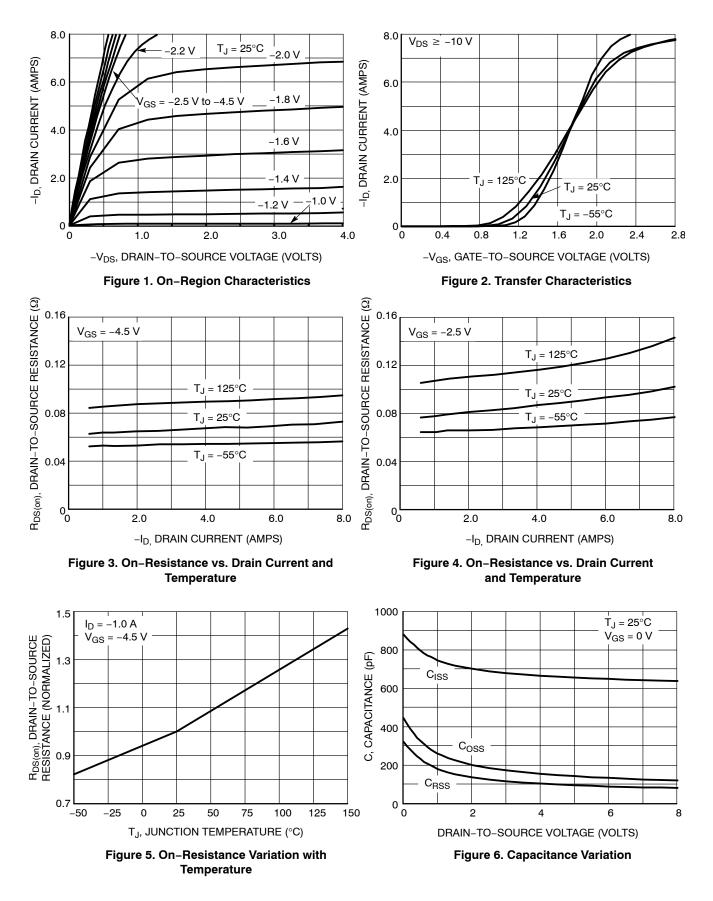
DRAIN-SOURCE DIODE CHARACTERISTICS

Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = -0.3 A	$T_J = 25^{\circ}C$	-0.62	-1.2	V
		$I_{S} = -0.3 \text{ A}$	T _J = 125°C	-0.51		
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 V, dI_{SD}/dt$ $I_{S} = -1.$	t = 100 A/μs,	23.4		ns
Charge Time	Τ _a	I _S = –1.0 A		7.7		
Discharge Time	Т _b			15.7		
Reverse Recovery Charge	Q _{RR}			9.5		nC

2. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%. 3. Switching characteristics are independent of operating junction temperatures.

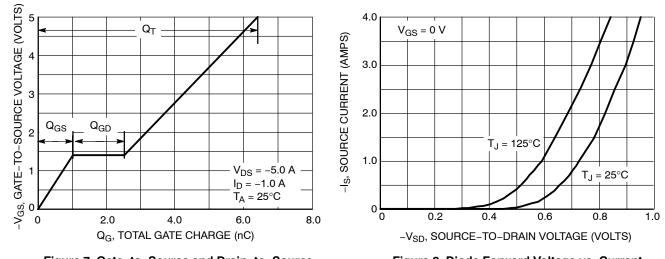
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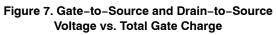
TYPICAL ELECTRICAL CHARACTERISTICS

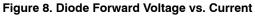


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TYPICAL ELECTRICAL CHARACTERISTICS

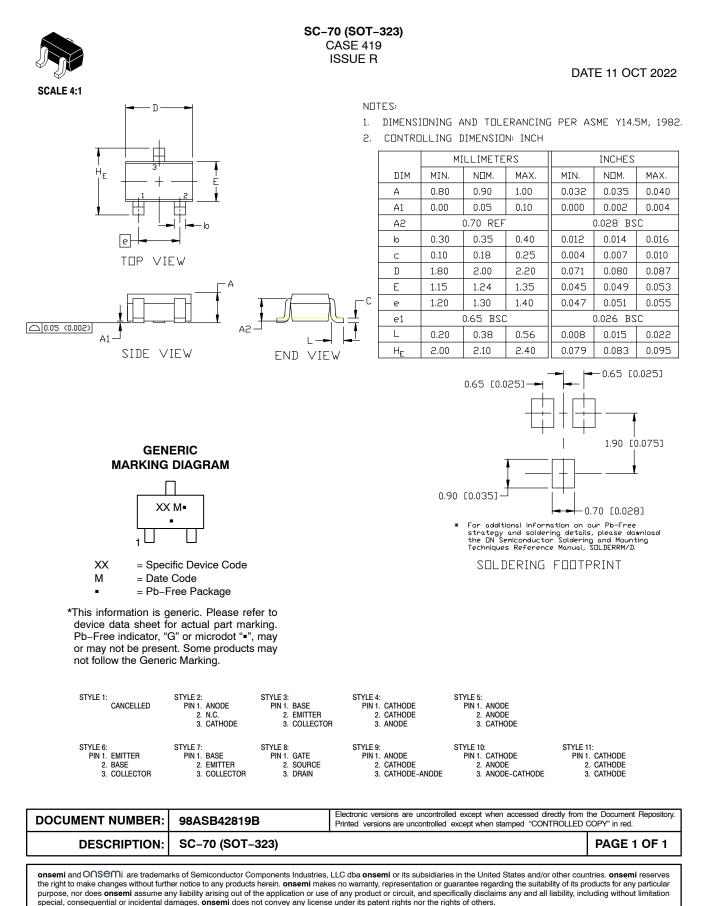






MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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